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| AGENT  | :    |  |  |  |

# SPECIFICATION of PYROELECTRIC PASSIVE INFRARED SENSOR

| MODEL NO. : | SW-ULP23-20 |
|-------------|-------------|
|-------------|-------------|

## NIPPON CERAMIC CO., LTD.

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|             |              |      |      |                          |



## 1. SCOPE

This specification describes a Pyroelectric Passive Infrared Sensor supplied by Nippon Ceramic Co., Ltd.

## 2. TYPE of SENSOR

Balanced differential type. (series opposed type.) Built - in amplifier circuit.

## 3. PHYSICAL CONFIGURATION

Table 1

|      | PARAMETER           | SPECIFICATION  |
|------|---------------------|--|
| 3.1. | Package             | TO-5 metal can with dimensions shown in Fig.1. (Nickel-plated) |
| 3.2. | Element geometry    | Four sensitive areas 2.3 mm * 0.75 mm and spaced 0.6 mm apart. |
| 3.3. | Element orientation | See Fig.1  |
| 3.4. | Lead configuration  | See Fig.1  |

## 4. ELECTRICAL CHARACTERISTICS

{ at 25 (+/-) 5 [degrees Celsius] , Vdd = 3.3V}

Table 2

|      | PARAMETER                         | CONDITION   | SPECIFICATION                      |
|------|-----------------------------------|---|------------------------------------|
| 4.1. | Supply Voltage(Vdd)               | Single Power Supply   | 1.8 ~ 3.4 V                        |
| 4.2. | Output Voltage                    | Single Power Supply   | 0 ~ Vdd V                          |
| 4.3. | Offset Voltage                    | Without Incident Infrared Energy  | 1.65 (+/-) 0.1 V                   |
| 4.4. | Current consumption               | -   | Max. 1 μ A<br>(Typ. 0.8 μ A)       |
| 4.4. | Signal Output                     | Incident Infrared Energy: 13 microW / cm <sup>2</sup> from 420 K Black Body Chopping Frequency: 1 Hz by Measurement method shown in Fig. 2. | Min. 0.75 Vp-p<br>(Typ. 1.5 Vp-p)  |
| 4.5. | Noise Output                      | Under shut out from Infrared Energy by Measurement method shown in Fig. 2.  | Max. 250 mVp-p<br>(Typ. 100 mVp-p) |
| 4.6. | Balance Output                    | Incident Infrared Energy: 13 microW / cm <sup>2</sup> from 420 K Black Body Chopping Frequency: 1 Hz by Measurement method shown in Fig. 2. | [Bo /  SA+SB ]<br>=< 0.15          |
|      |                                   | Bo : Balance output SA : Signal output on Element A SB : Signal output on Element B   |                                    |
| 4.8. | Waiting Time after supplied Power | -   | Max. 90 sec.                       |
| 4.9. | Circuit Configuration             | See Fig. 3  |                                    |

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#### **5. OPTICAL CHARACTERISTICS**

Table 3

|      | PARAMETER                    | SPECIFICATION                                |
|------|------------------------------|--|
| 5.1. | Field of View                | 134° from center of element on axis X        |
|      |                              | 120° from center of element on axis Y        |
|      |                              | See Fig. 1                                   |
| 5.2. | Response wavelength band     | Filter Substrate : Silicon                   |
|      |                              | Cut On (5 %T ABS) : 5.0 (+/-) 0.5 micron     |
|      |                              | Transmission : >= 70 % Average 7 ~ 14 micron |
| 5.3. | Transmission Characteristics | See Fig. 4                                   |
|      | of Filter                    |  |

#### **6. ENVIRONMENTAL REQUIREMENTS**

Table 4

| PARAMETER |                       | SPECIFICATION  |
|-----------|-----------------------|--|
| 6.1.      | Operating Temperature | - 40 ~ 70 degrees Celsius  |
| 6.2.      | Storage Temperature   | - 50 ~ 80 degrees Celsius  |
| 6.3.      | Relative Humidity     | The Sensor shall operate without increase in Noise Output when exposed to 90 $\sim$ 95 $\%$ RH at 30 degrees Celsius continuously. |
| 6.4.      | Hermetic Seal         | The Sensor shall be sealed withstand a vacuum of 21.28 kPa.  |

#### 7. NOTES

#### 7.1. Design restrictions/precautions

If used for outdoor applications, be sure to apply suitable supplementary optical filter, drip-proof and anti-dew construction. This Sensor is designed for indoor use.

In cases where secondary accidents due to operation failure or malfunctions can be anticipated, add a fail safe function to the design.

## 7.2. Usage restrictions/precautions

To prevent Sensor malfunctions, operational failure or any deterioration of its characteristics, do not use this Sensor in the following, or similar, conditions.

- 7.2.1. In rapid environmental temperature changes.
- 7.2.2. In strong shock or vibration.
- 7.2.3. In a place where there are obstructing materials (Glass, Fog, etc.) through which infrared rays cannot pass within detection area.
- 7.2.4. In fluid, corrosive gases and sea breeze.
- 7.2.5. Continual use in high humidity atmosphere.
- 7.2.6. Exposed to direct sun light or headlight of automobiles.
- 7.2.7. Exposed to direct wind from a heater or air conditioner.

## 7.3. Assembly restrictions/precautions

## 7.3.1. Soldering

- a. Use soldering irons when soldering.
- b. Avoid keeping pins of this Sensor hot for a long time as excessive heat may cause deterioration of its quality. (e.g. within 5 sec. at 350 degrees Celsius.)

#### 7.3.2. Washing

- a. Be sure to wash out all flux after soldering as remainder may cause malfunctions.
- b. Use a brush when washing. Washing with an ultrasonic cleaner may cause operational failure.

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## 7.4. Handling and storage restrictions/precautions

To prevent Sensor malfunctions, operational failure, appearance damage or any deterioration of its characteristics, do not expose this Sensor to the following or similar, handling and storage conditions.

- 7.4.1. Vibration for a long time.
- 7.4.2. Strong shock.
- 7.4.3. Static electricity or strong electromagnetic waves.
- 7.4.4. High temperature and humidity for a long time.
- 7.4.5. Corrosive gases or sea breeze.
- 7.4.6. Dirty and dusty environments that may contaminate the optical window.

Sensor troubles resulting from misuse, inappropriate handling or storage are not the manufacturer's responsibility.

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## Configuration (Figure 1)

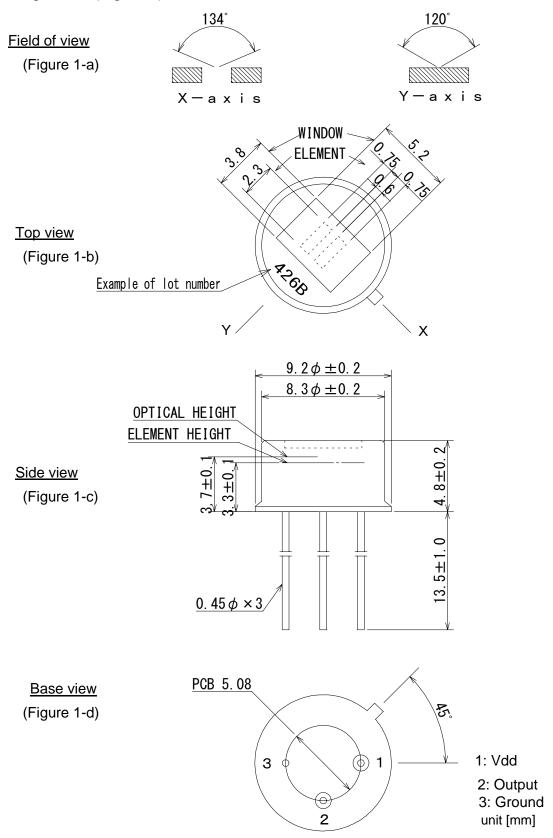
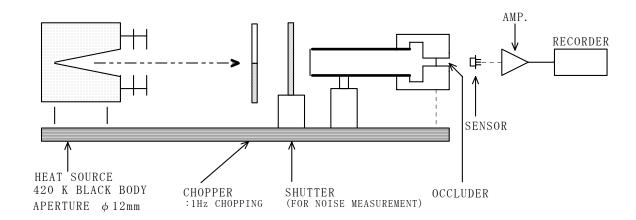


Fig. 1 : Dimensions (Flat package type)

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## Occluder Position

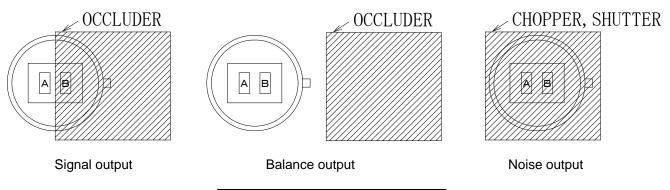


Fig. 2 : Test Set-up Block Diagram

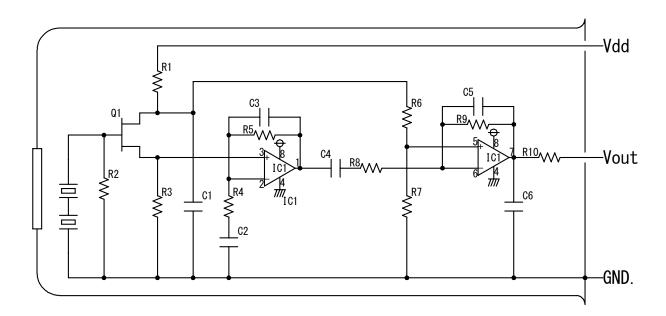


Fig. 3 : Circuit Configuration

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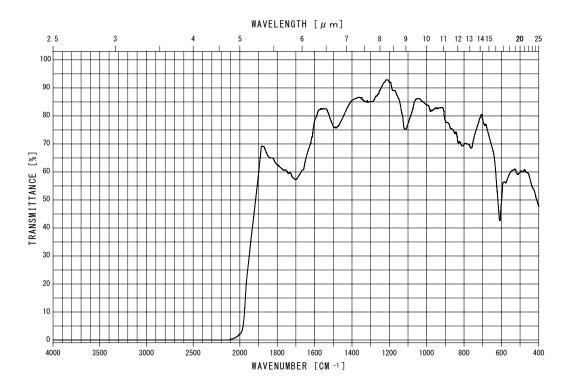


Fig. 4 : Typical Transmission Characteristics of Filter

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